

致尊敬的顾客

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## 关于产品目录等资料中的旧公司名称

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瑞萨电子公司网址：<http://www.renesas.com>

2010年4月1日  
瑞萨电子公司

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## 接口IC

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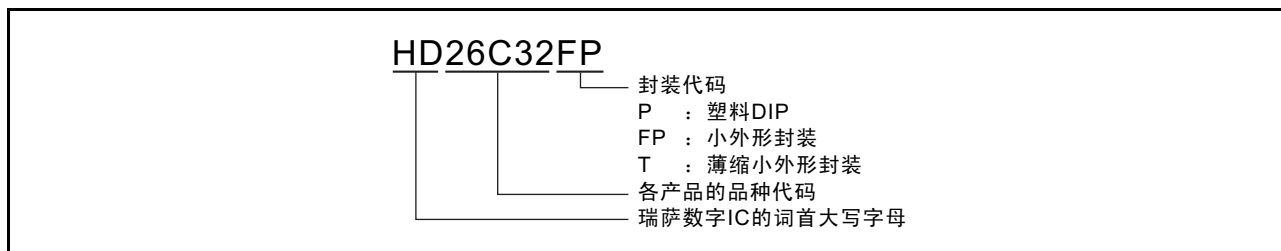


图1 封装的名称

#### 2. 封装的热阻

##### 2.1 塑料DIP封装

引脚个数	14、16Pin	20Pin
热电阻 $\theta_{j-a}$ (°C/W)	105	90
减额因子 (mW/°C)	9.5	11.0
容许损耗 (mW)	1185	1375

##### 2.2 小外形封装

引脚个数	8Pin	14、16Pin	20Pin
热电阻 $\theta_{j-a}$ (°C/W)	170	160	150
减额因子 (mW/°C)	5.9	6.3	6.7
容许损耗 (mW)	735	785	835

##### 2.3 薄缩小外形封装

引脚个数	16Pin	20Pin	24Pin
热电阻 $\theta_{j-a}$ (°C/W)	250	165	145
减额因子 (mW/°C)	4.0	6.1	6.9
容许损耗 (mW)	500	757	862

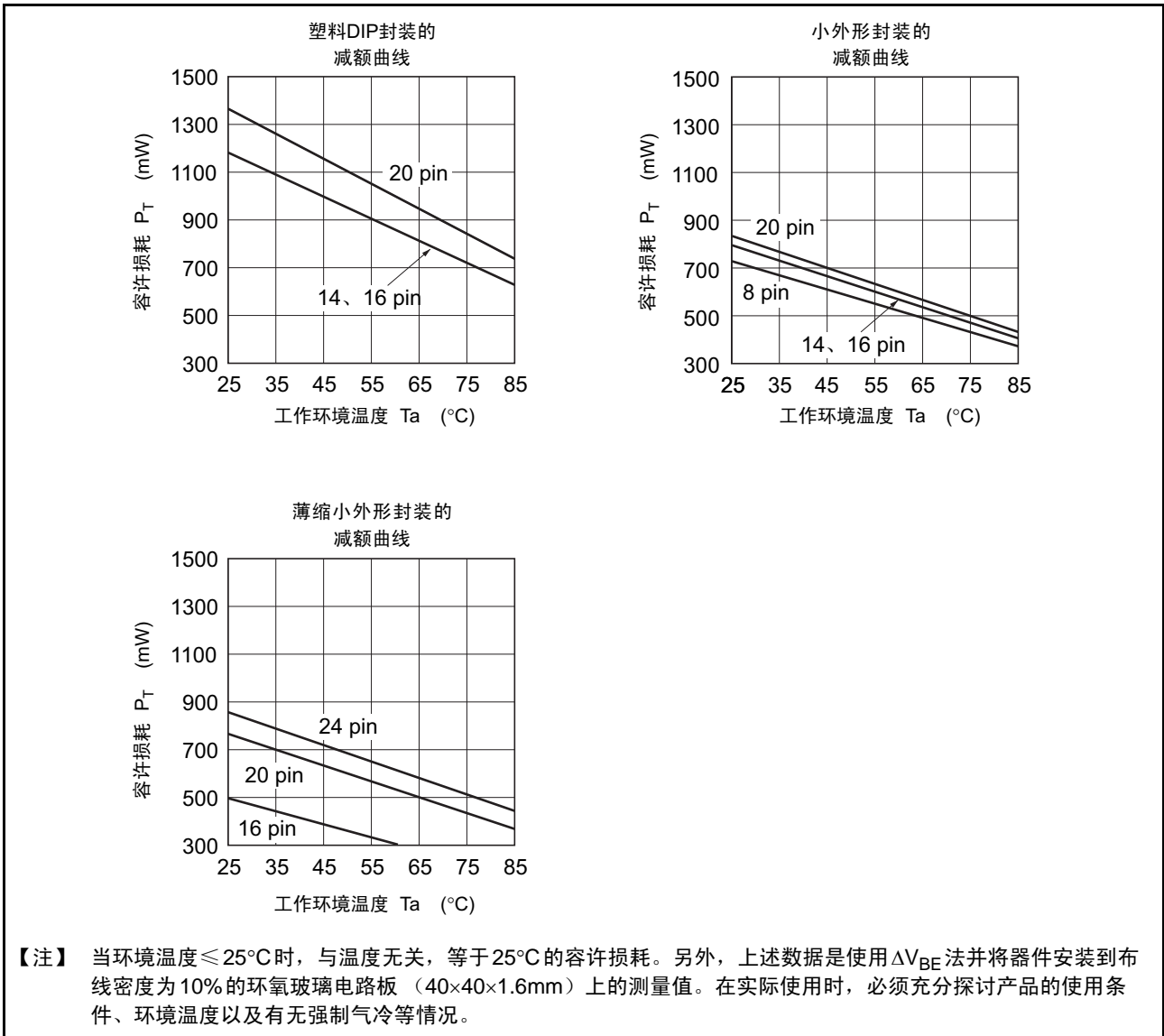


图2 减额曲线

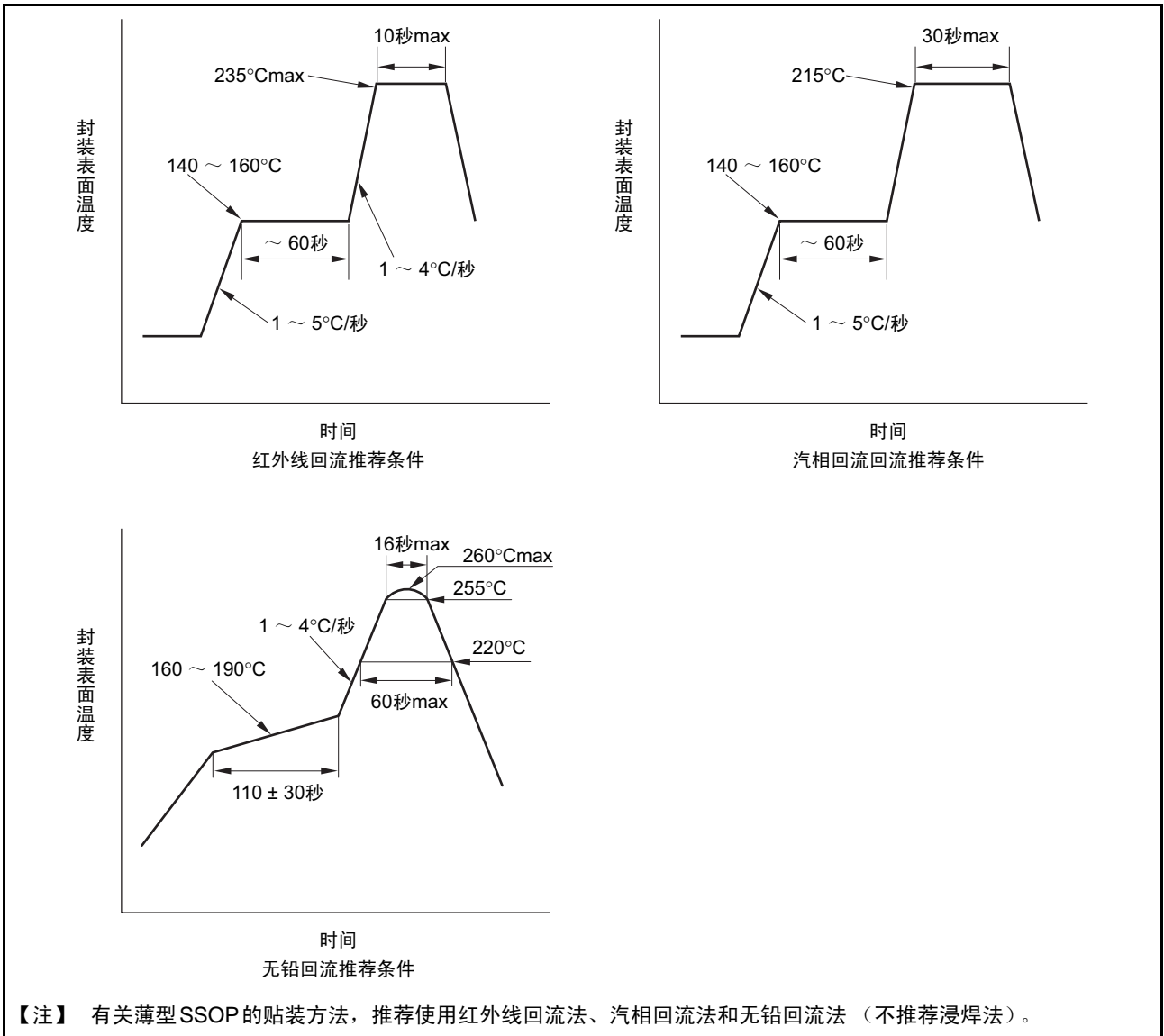


图3 TSSOP的贴装方法

修订记录

Rev.	发行日	修订内容	
		页	修订处
1.00	2008.03.25	一	初版发行

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